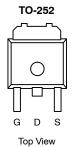


N-Channel 20-V (D-S)175 °C MOSFET

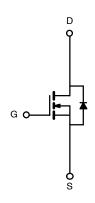
PRODUCT SUMMARY					
V _{DS} (V)	r _{DS(on)} (Ω)	I _D (A) ^a			
00	0.006 @ V _{GS} = 4.5 V	65			
20	0.008 @ V _{GS} = 2.5 V	45			

FEATURES

- TrenchFET[®] Power MOSFET
- 175°C Maximum Junction Temperature
- 100% Rg Tested



Drain Connected to Tab



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _A = 25°C UNLESS OTHERWISE NOTED)						
Parameter		Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	20	v			
Gate-Source Voltage		V _{GS}	±15	V		
	$T_{C} = 25^{\circ}C$		65			
Continuous Drain Current ^a	$T_{C} = 100^{\circ}C$		42			
Pulsed Drain Current		I _{DM}	200	A		
Continuous Source Current (Diode Conduction) ^a		Is	65			
	$T_{C} = 25^{\circ}C$	_	71			
Maximum Power Dissipation	$T_A = 25^{\circ}C$	P _D —	8.3 ^{b, c}	w		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C		

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Typical	Maximum	Unit			
	$t \leq 10$ sec.		15	18	°C/W		
Maximum Junction-to-Ambient ^b	Steady State	R _{thJA}	40	50			
Maximum Junction-to-Case		R _{thJC}	1.75	2.1			

Notes

- a. Package Limited
- b. Surface Mounted on 1" x 1" FR4 Board

c. $t \leq 10 \text{ sec}$

Г

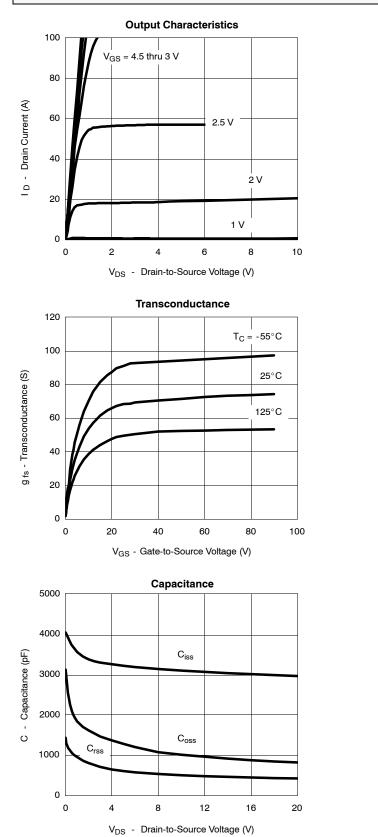
Parameter	Symbol	Test Condition Min		Тура	Max	Unit
Static				1	1	
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I_D = 250 μ A	20			v
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS},I_{D}=250\;\mu A$	0.5		1.5	v
Gate-Body Leakage	I _{GSS}	V_{DS} = 0 V, V_{GS} = \pm 12 V			±100	nA
		$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = 20 V, V_{GS} = 0 V, T_{J} = 125 $^{\circ}\text{C}$			50	μΑ
On-State Drain Current ^b	I _{D(on)}	V_{DS} = 5 V, V_{GS} = 4.5 V	65			А
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 20 \text{ A}$ 0.		0.0045	0.006	Ω
Drain-Source On-State Resistance ^b	r _{DS(on)}	V_{GS} = 4.5 V, I _D = 20 A, T _J = 125°C		0.0055	0.007	
		$V_{GS} = 2.5 \text{ V}, \text{ I}_{D} = 20 \text{ A}$		0.006	0.008	
Forward Transconductanceb	9fs	$V_{DS} = 5 \text{ V}, \text{ I}_{D} = 40 \text{ A}$	20			S
Dynamic ^a	· · ·					
Input Capacitance	C _{iss}			3660		pF
Output Capacitance	C _{oss}	V_{GS} = 0 V, V_{DS} = 20 V, f = 1 MHz		730		
Reverse Transfer Capacitance	C _{rss}			375		
Total Gate Charge ^c	Qg			26	35	nC
Gate-Source Charge ^c	Q _{gs}	V_{DS} = 10 V, V_{GS} = 4.5 V, I_{D} = 40 A		5		
Gate-Drain Charge ^c	Q _{gd}			7		
Gate Resistance	Rg		1		3.7	Ω
Turn-On Delay Time ^c	t _{d(on)}			20	35	
Rise Time ^c	t _r	V_{DD} = 10 V, R_L = 0.25 Ω		120	190	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong$ 40 Å, V_{GEN} = 4.5 V, R_G = 2.5 Ω		45	70	- ns
Fall Time ^c	t _f			20	35	
Source-Drain Diode Ratings and	d Characteristi	c (T _C = 25°C)				
Pulsed Current	I _{SM}				100	А
Diode Forward Voltage ^b	V _{SD}	I _F = 100 A, V _{GS} = 0 V		1.2	1.5	V
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 40 A, di/dt = 100 A/μs	1	35	70	ns

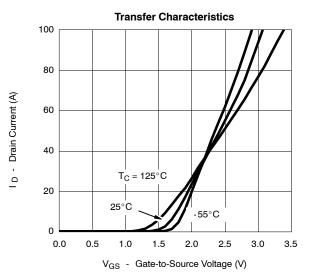
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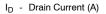


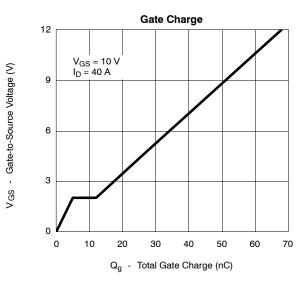
TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)



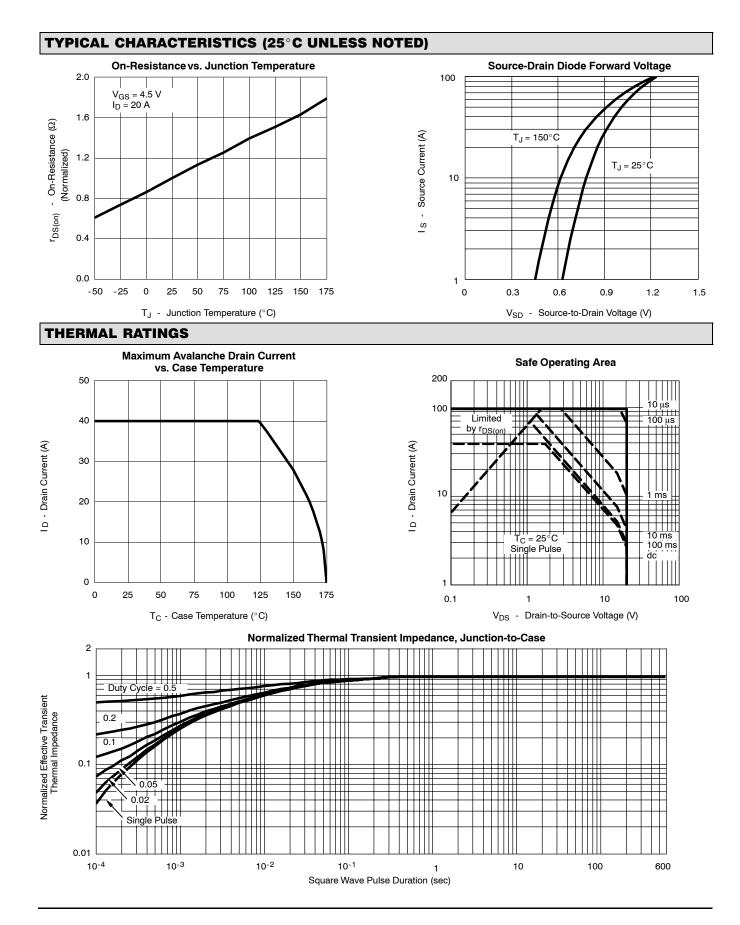


On-Resistance vs. Drain Current 0.012 0.009 $V_{GS} = 2.5 V$ 0.000 0.000 $V_{GS} = 4.5 V$ 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.000 0.0000 0.000 0.000 0.0000 0.000 0.0000 0.0000 0.000



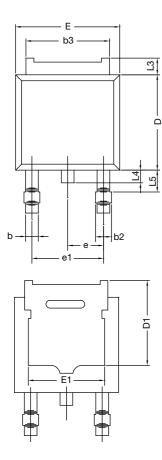


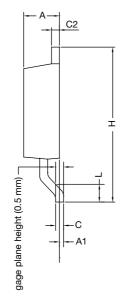






TO-252AA CASE OUTLINE





	MILLIMETERS		INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
А	2.18	2.38	0.086	0.094	
A1	-	0.127	-	0.005	
b	0.64	0.88	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	
С	0.46	0.61	0.018	0.024	
C2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	
D1	5.21	-	0.205	-	
E	6.35	6.73	0.250	0.265	
E1	4.32	-	0.170	-	
Н	9.40	10.41	0.370	0.410	
е	2.28	BSC	0.090	BSC	
e1	4.56 BSC		0.180 BSC		
L	1.40	1.78	0.055	0.070	
L3	0.89	1.27	0.035	0.050	
L4	-	1.02	-	0.040	
L5	1.14	1.52	0.045	0.060	
ECN: X12-0247-Rev. M, 24-Dec-12 DWG: 5347					

Note

• Dimension L3 is for reference only.



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